19-4474; Rev 0; 2/09

Microsemi

MAX3673 Evaluation Kit

Evaluates: MAX3673

General Description

The MAX3673 evaluation kit (EV kit) is a fully assembled and tested demonstration board that simplifies evaluation of the MAX3673 low-jitter frequency synthesizer with selectable input reference. The EV kit includes slide switches to allow easy selection of different modes of operation. Clock I/Os have SMA connectors and are AC-coupled to simplify connection to test equipment. The EV kit is powered by a +3.3V supply and uses LEDs for signal status indicators.

Features

- **Fully Assembled and Tested**
- **Slide Switches for Mode Control**
- **SMA Connectors and AC-Coupled Clock I/Os**
- **Powered by +3.3V Supply**
- **LED Signal Status Indicators**

Ordering Information

PART	TYPE
MAX3673EVKIT+	EV Kit

+Denotes lead(Pb)-free and RoHS compliant.

Component List

DESIGNATION	QTY	DESCRIPTION
C1, C6, C7 C11–C13, C16, C18–C22, C24–C27, C29, C30, C32–C39, C41, C42, C46–C50, C62, C63	35	0.1µF ±10% ceramic capacitors (0402)
C2	1	33µF ±5% tantalum capacitor (B case)
C3	1	2.2µF ±10% ceramic capacitor (0805)
C4	1	0.1µF ±10% ceramic capacitor (0603)
C5	1	0.01µF ±10% ceramic capacitor (0603)
C28	1	0.22µF ±10% ceramic capacitor (0402)
D1, D3, D8	3	Green SMD LEDs (1206) Panasonic LNJ311G8PRA
D2, D4, D7	3	Red SMD LEDs (1206) Panasonic LNJ211R8ARA
J1, J2, J5–J12, J14, J15, J19, J20, J22–J29, J44, J45	24	SMA connectors, edge-mount, tab center Johnson 142-0701-851
J4, J13	2	Test points Keystone 5000
L1	1	4.7µH ±20% inductor Taiyo Yuden CBC3225T4R7M
R1–R5, R15, R16, R17, R37–R46	18	150Ω ±1% resistors (0402)
R6–R11	6	49.9Ω ±1% resistors (0402)
R12, R13, R14, R18, R21, R22	6	332Ω ±1% resistors (0603)
R23, R24, R25	3	10kΩ ±1% resistors (0603)
S1	1	Switch, momentary, SPST-NO Panasonic EVQQ2S02W
S2, S3, S5	3	Switches, slide, SPDT Copal Electronics CUS-12TB
S6, S7, S8	3	Switches, slide, SP4T Copal Electronics CUS-14TB
S9, S10	2	Switches, slide, SP3T Copal Electronics CUS-13TB
TP3, TP20	2	Test points Keystone 5000
U1, U2, U4	3	Dual inverters (6 SC-70) TI SN74LVC2G14DCKR
U7	1	Low-jitter, frequency synthesizer with selectable input reference (56 TQFN) Microsemi MAX3673ETN+
None	1	PCB: MAX3673 EV Kit+ Circuit Board, Rev A

MAX3673 Evaluation Kit

Quick Start

1) Set the slide switches to the following settings:
   PLL_BYPASS = NORMAL
   SEL_CLK = REFCLK0
   DM = 61.44M
   DA = 122.88M
   DB = 122.88M
   $\overline{\text{OUTA\_EN}}$ = A0, A1
   $\overline{\text{OUTB\_EN}}$ = B0
   FB_SEL = INTERNAL
2) Connect a +3.3V supply to VCC (J13) and GND (J4). Set the supply current limit to 450mA.
3) Using SMA cables, connect a low-jitter 61.44MHz differential clock source to the REFCLK0 input. Verify that the green LEDs switch on for $\overline{\text{IN0FAIL}}$ and $\overline{\text{LOCK}}$.
4) Using SMA cables, connect the OUTA0 output to test equipment. Terminate all unused enabled outputs (OUTB0 and OUTA1).

Detailed Description

The MAX3673 EV kit simplifies evaluation by providing the hardware needed to evaluate all the MAX3673 functions. Table 1 contains functional descriptions for the switches and indicators.

Clock Inputs

The clock inputs (REFCLK0, REFCLK1, FB_IN) are AC-coupled at the SMA connectors and have on-board 100Ω differential terminations. For optimal jitter performance it is critical to use a low-jitter, differential, square-wave clock source. If such a source is not available, the clock inputs can be driven with a single-ended sinusoidal or square-wave clock source for functional testing.

Clock Outputs

The clock outputs (OUTA[3:0], OUTB[4:0]) have on-board DC-biasing and are AC-coupled at the SMA connectors to allow direct connection to 50Ω-terminated test equipment. Unused outputs should be disabled (using switches S9 and S10) or have 50Ω terminations placed on the SMA connectors.

Table 1. Switch and Indicator Descriptions

COMPONENT	NAME	FUNCTION
S1	MASTER RESET	Momentary switch to reset internal dividers. Not required at power-up. If the output divider settings (DA, DB) are changed on the fly, a reset is required to phase align the outputs.
S2	PLL_BYPASS	Selects normal PLL operation or PLL bypass.
S3	SEL_CLK	Selects the reference clock input.
S5	FB_SEL	Selects internal or external feedback for the PLL. If external is selected, connect any of the A-group or B-group outputs to the FB_IN input. If DA ≠ DB, a B-group output must be used.
S6	DM	Selects the frequency of the reference clock inputs.
S7	DA	Selects the frequency of the A-group clock outputs.
S8	DB	Selects the frequency of the B-group clock outputs.
S9	$\overline{\text{OUTA\_EN}}$	Selects which A-group outputs are enabled (see Note).
S10	$\overline{\text{OUTB\_EN}}$	Selects which B-group outputs are enabled (see Note).
D1, D2	$\overline{\text{IN0FAIL}}$	REFCLK0 failure indicator (green = pass, red = fail).
D3, D4	$\overline{\text{IN1FAIL}}$	REFCLK1 failure indicator (green = pass, red = fail).
D7, D8	$\overline{\text{LOCK}}$	PLL lock indicator (green = PLL locked, red = PLL not locked).

Note: *Setting $\overline{\text{OUTA\_EN}}$ = "—" and $\overline{\text{OUTB\_EN}}$ = "B0" at the same time enables a factory test mode and is not a valid mode of operation.*

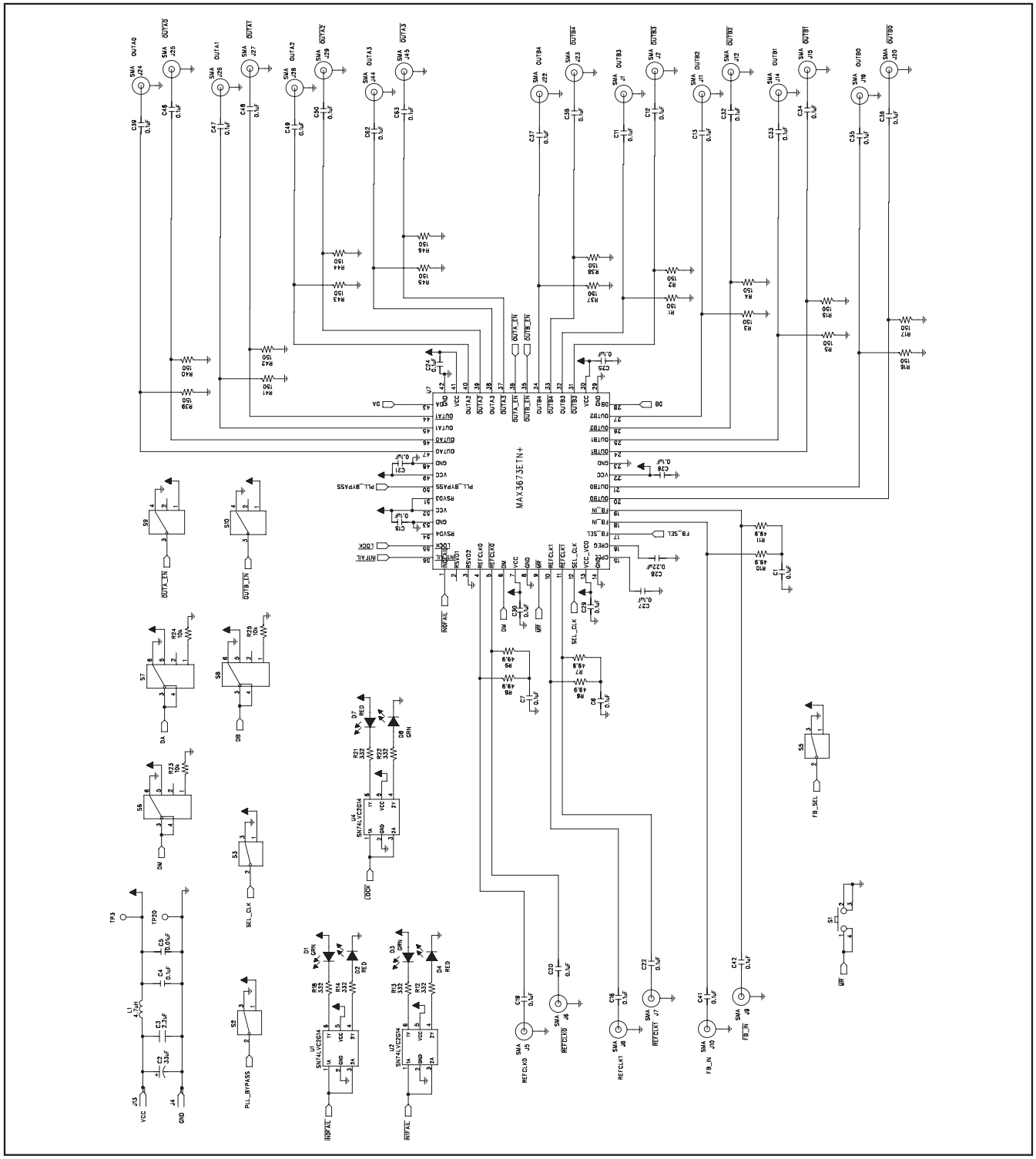


Figure 1. MAX3673 EV Kit Schematic

MAX3673 Evaluation Kit

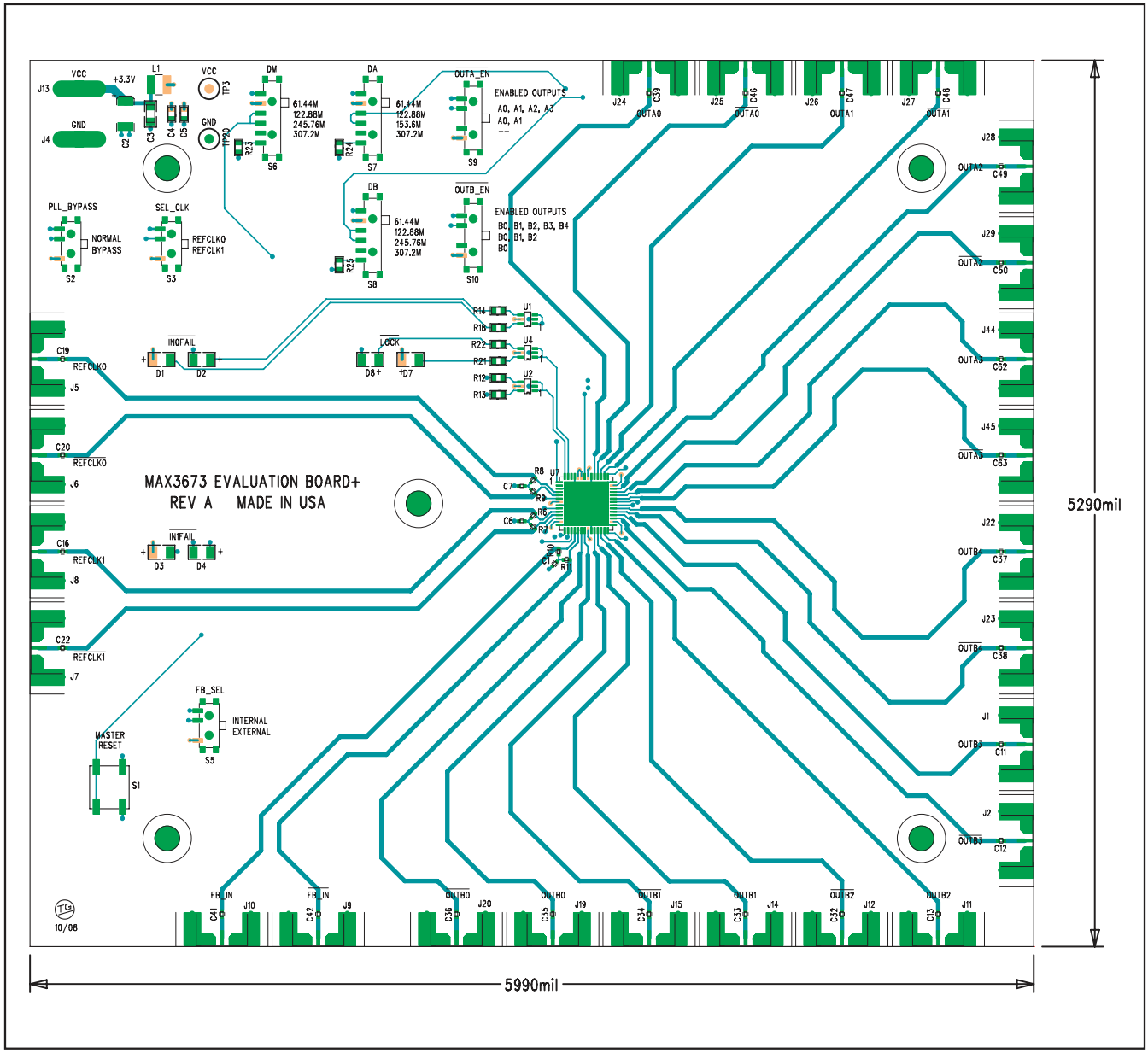


Figure 2. MAX3673 EV Kit Component Placement Guide—Component Side

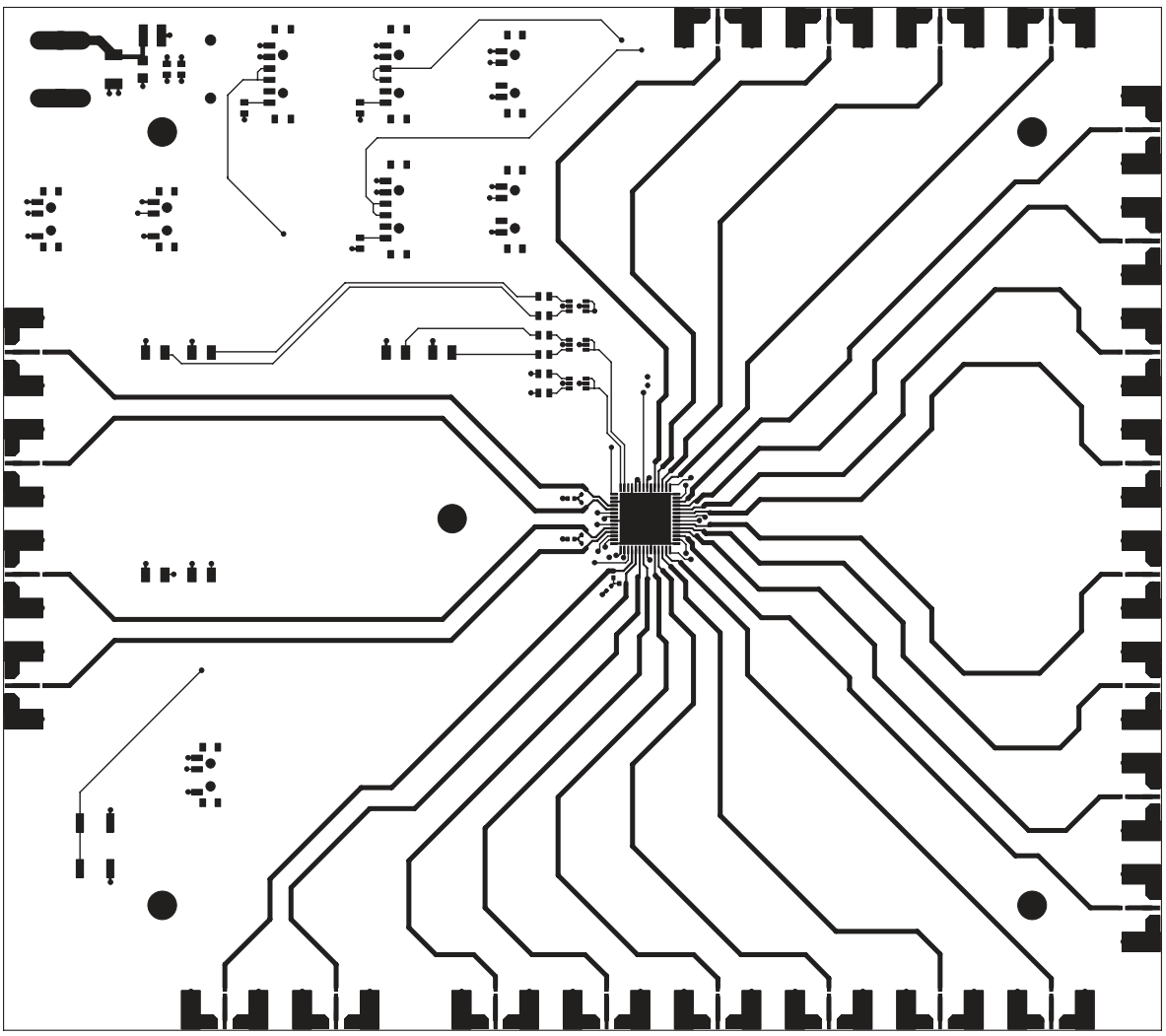


Figure 3. MAX3673 EV Kit PCB Layout—Component Side

MAX3673 Evaluation Kit

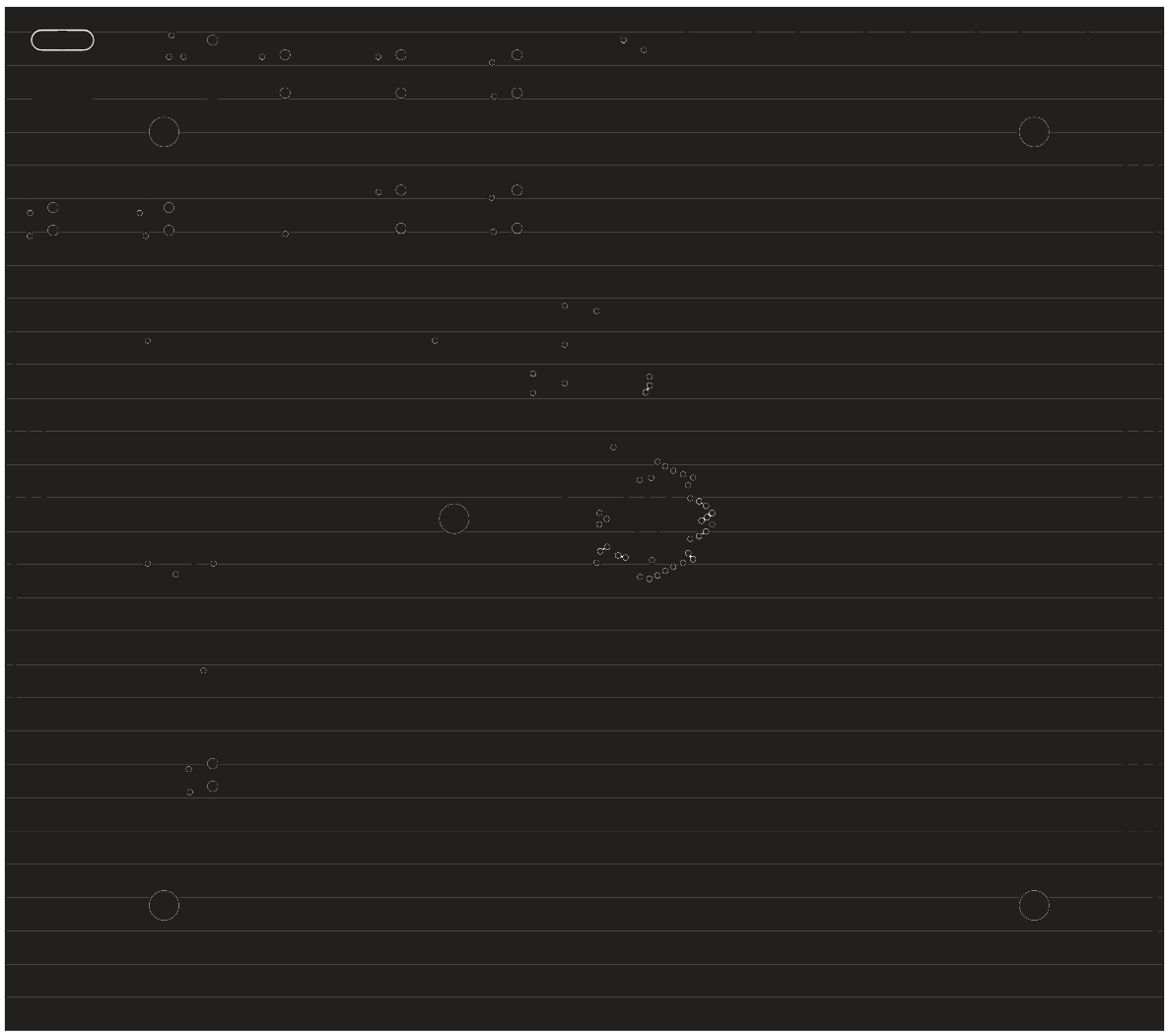


Figure 4. MAX3673 EV Kit PCB Layout—Ground Plane

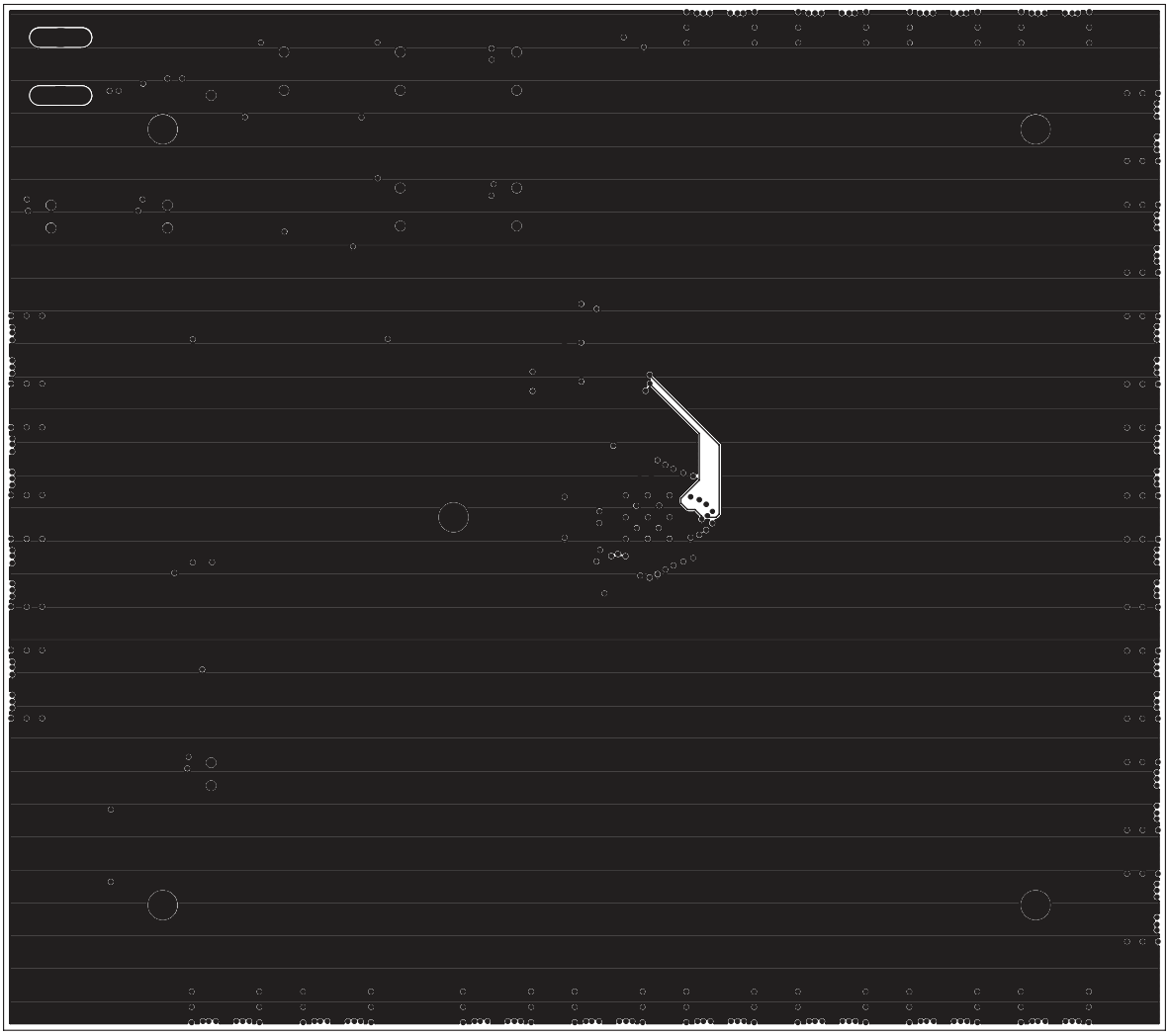


Figure 5. MAX3673 EV Kit PCB Layout—Power Plane

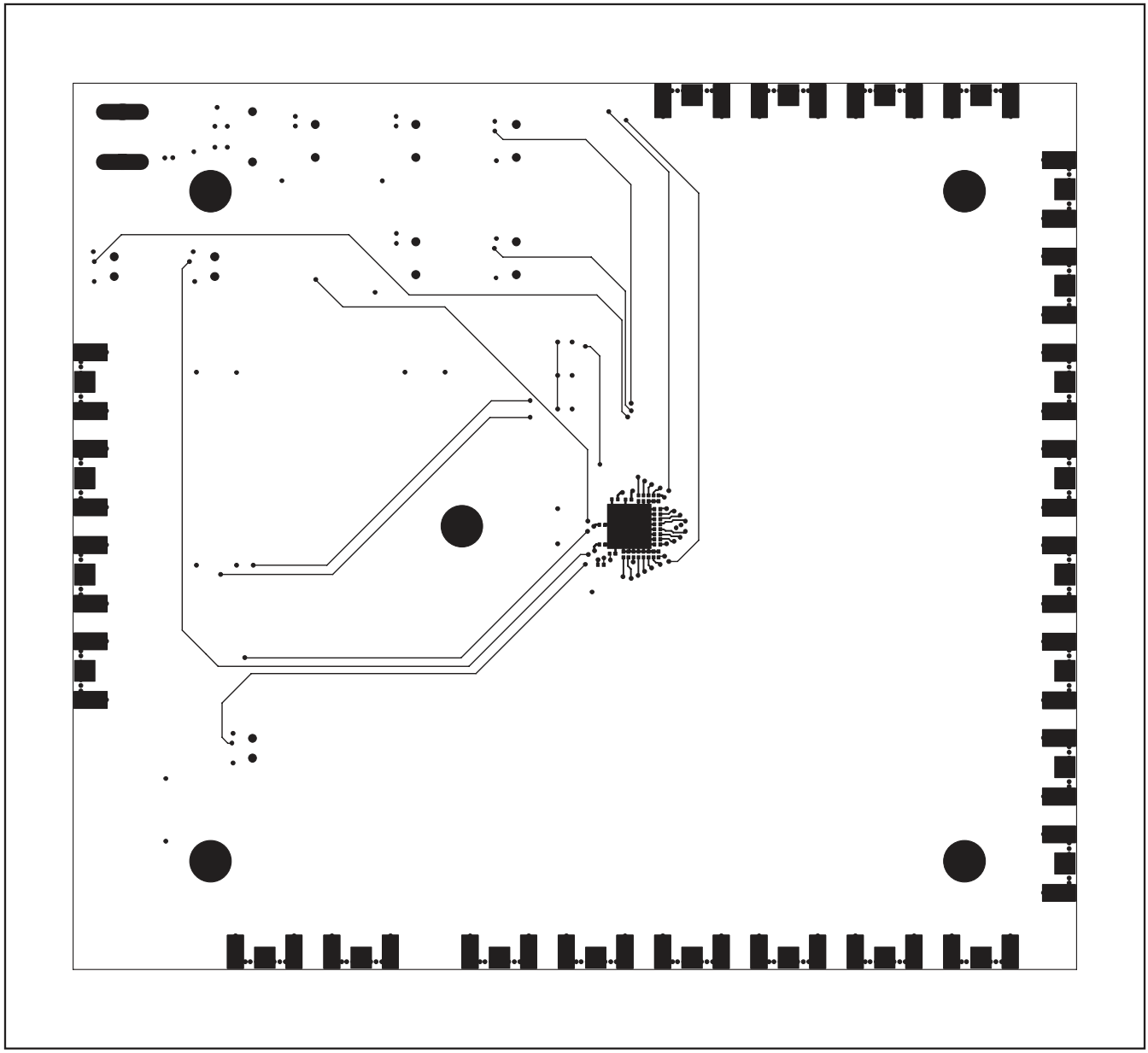


Figure 6. MAX3673 EV Kit PCB Layout—Solder Side

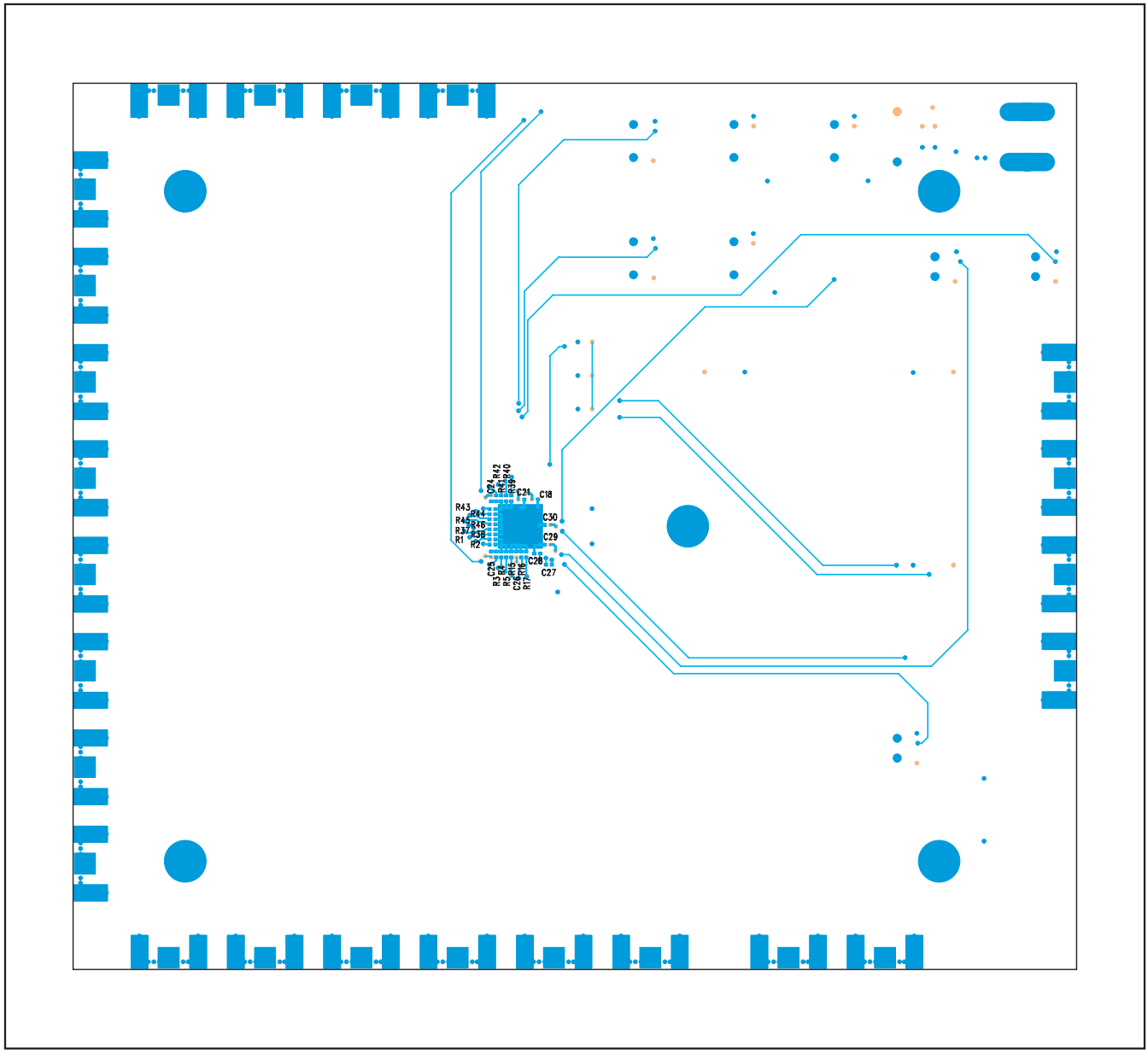
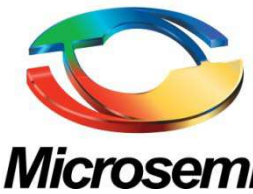


Figure 7. MAX3673 EV Kit Component Placement Guide—Solder Side



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